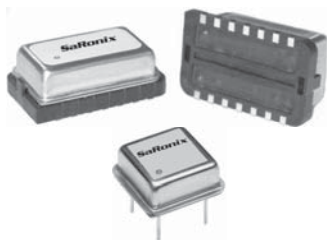


Technical Data

NTH / NCH Series



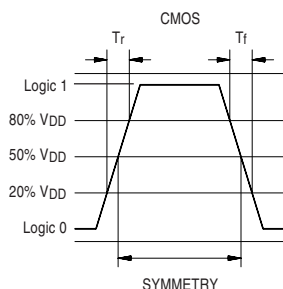
Description

A crystal controlled, low current, low jitter and high frequency oscillator with precise rise and fall times demanded in networking applications. The tri-state function on the NTH enables the output to go high impedance. Device is packaged in a 14 or an 8-pin DIP compatible resistance welded, all metal grounded case to reduce EMI. True SMD DIL14 versions for IR reflow are available, select option "S" in part number builder. See separate data sheet for SMD package dimensions.

Applications & Features

- ADSL, DSL
- DS3, ES3, E1, STS-1, T1
- Ethernet Switch, Gigabit Ethernet
- Fibre Channel Controller
- MPEG
- Network Processors
- Voice Over Packet
- 32 Bit Microprocessors
- Tri-State output on NTH
- LVCMOS / HCMOS compatible
- Available up to 106.25 MHz

Output Waveform

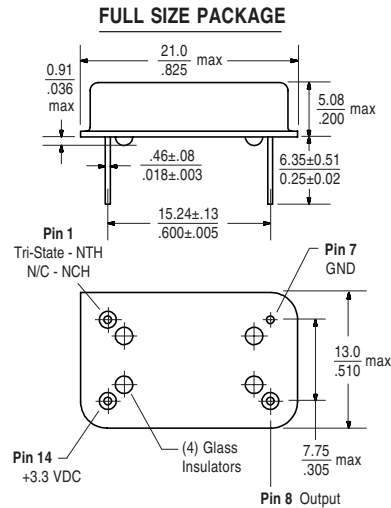


Frequency Range:	0.5 MHz to 106.25 MHz
Frequency Stability:	±20, ±25, ±50 or ±100 ppm over all conditions: calibration tolerance, operating temperature, input voltage change, load change, 30 day aging, shock and vibration.
Temperature Range:	
Operating:	0 to +70°C or -40 to +85°C, See Part Numbering Guide
Storage:	-55 to +125°C
Supply Voltage:	
Recommended Operating:	3.3V ±10%
Supply Current:	
	20mA max, 0.5 to 30 MHz
	25mA max, 30+ to 50 MHz
	30mA max, 50+ to 80 MHz
	35mA max, 80+ to 106.25 MHz
Output Drive:	
HCMOS	Symmetry: 45/55% max 0.5 to 70 MHz max 40/60% max @ 50% VDD
Rise and Fall Times:	4ns max 0.5 to 50 MHz, 20% to 80% VDD 3ns max 50+ to 80 MHz 1.5ns max 80+ to 106.25 MHz
Logic 0:	10% VDD max
Logic 1:	90% VDD min
Load:	50pF, 0.5 to 50 MHz 30pF, 50+ to 70 MHz 15pF, 70+ to 106.25 MHz
Period Jitter RMS:	8ps max
Mechanical:	
Shock:	MIL-STD-883, Method 2002, Condition B
Solderability:	MIL-STD-883, Method 2003
Terminal Strength:	MIL-STD-883, Method 2004, Conditions A & C
Vibration:	MIL-STD-883, Method 2007, Condition A
Solvent Resistance:	MIL-STD-202, Method 215
Resistance to Soldering Heat:	MIL-STD-202, Method 210, Condition A, B or C
Environmental:	
Gross Leak Test:	MIL-STD-883, Method 1014, Condition C
Fine Leak Test:	MIL-STD-883, Method 1014, Condition A2
Thermal Shock:	MIL-STD-883, Method 1011, Condition A
Moisture Resistance:	MIL-STD-883, Method 1004

Technical Data

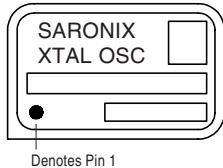
NTH / NCH Series

Package Details

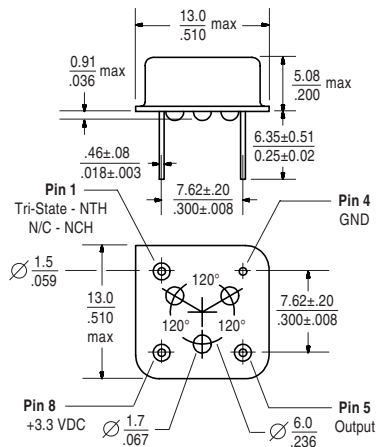


Standard Marking Format**

Includes Date Code, Frequency & Part Number



HALF SIZE PACKAGE



Standard Marking Format**

Includes Date Code, Frequency & Part Number



**Exact location of items may vary

Part Numbering Guide

NTH 0 8 0 C 3 - 40.0000 (T)

NTH = Pin 1: Tri state, LVCMOS
NCH = Pin 1: N/C, LVCMOS

Symmetry

0 = 40/60% max, 0 to 70°C
2 = 40/60% max, -40 to 85°C
A = 45/55% max, 0 to 70°C, 70 MHz max
C = 45/55% max, -40 to 85°C, 70 MHz max

Frequency Range

3 = 0.5 to 6 MHz
6 = 6+ to 24 MHz
8 = 24+ to 106.25 MHz

Package

0 = Full Size, Thru-Hole
9 = Half Size, Thru-Hole
K = Full Size, Gull Wing
J = Half Size, Gull Wing
N = Half Size, Gull Wing, Spanked Leads
S = Full Size, True SMD Adaptor (see separate data sheet for dimensions)

Packing Method

(T) = Tape & Reel for SMD versions,
full reel increments only, 200pcs (full
size) or 250pcs (half size)
Blank = Bulk

Frequency (MHz)

3.3V Supply

Stability Tolerance

C = ±100ppm
B = ±50ppm
A = ±25ppm, 0 to +70°C only
AA = ±20ppm, 0 to +70°C only

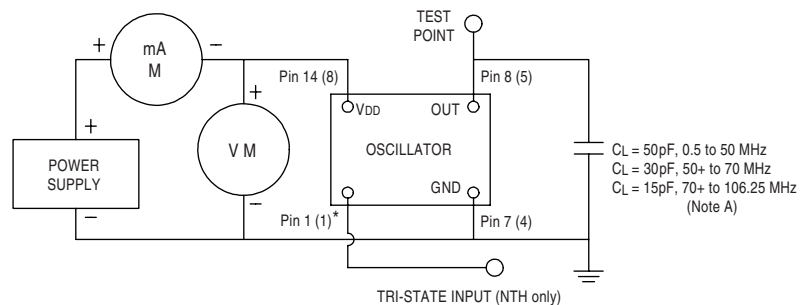
Tri-State Logic Table (NTH only)

Pin 1 Input	Pin 8 (5) Output
Logic 1 or NC	Oscillation
Logic 0 or GND	High Impedance

Required Input Levels on Pin 1:
Logic 1 = 2.2V min
Logic 0 = 0.8V max

Output: Oscillation @ V_{IN} , 2.2V min
Output: High Impedance @ V_{IN} , 0.8V max
Internal Pullup Resistance: 50K Ω min
Control Input: Disable Output Delay: 100ns max

Test Circuit



NOTE A: C_L includes probe and fixture capacitance

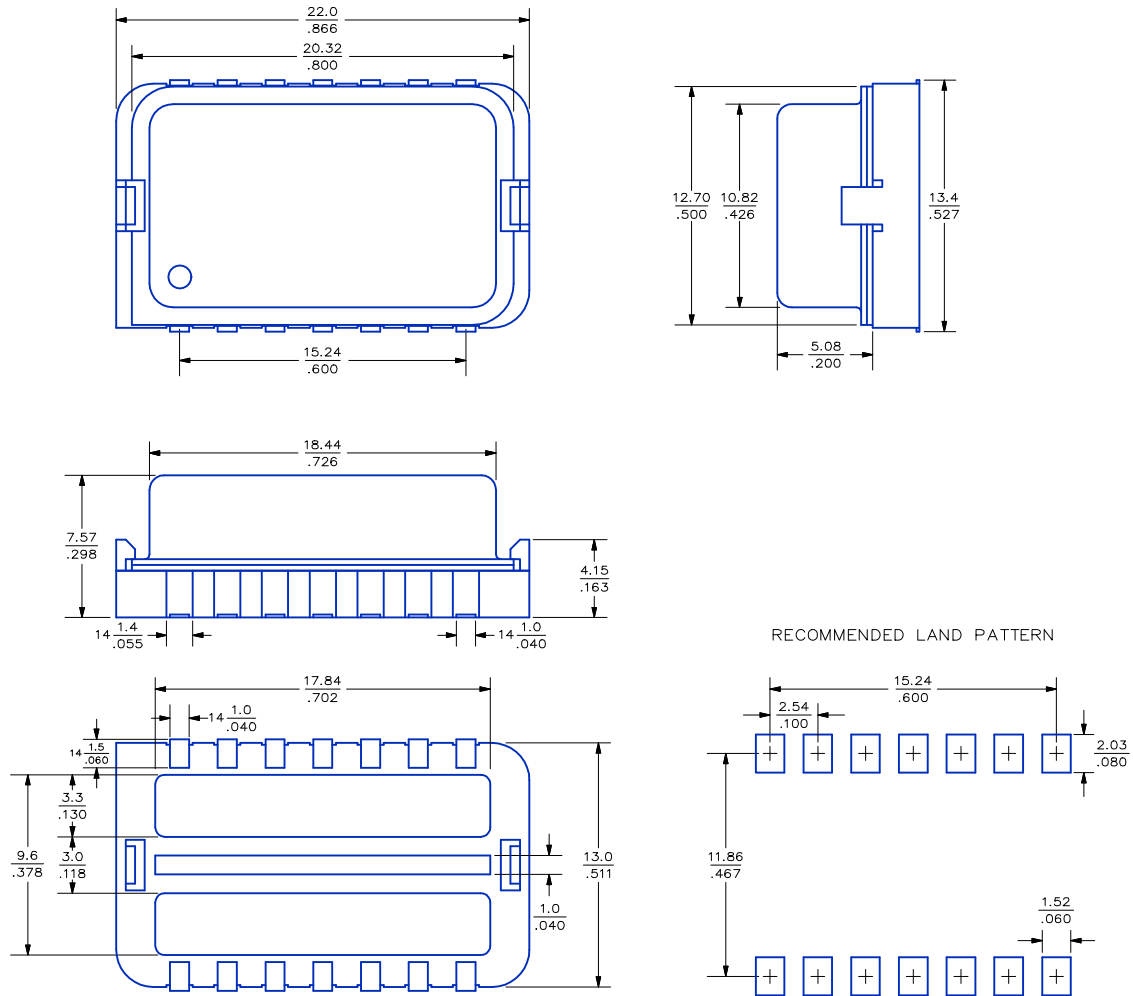
*() Indicates pin numbers for half-size package

All specifications are subject to change without notice.

DS-159 REV D

True SMD Adaptor - 7.57mm High

Technical Data



REV A